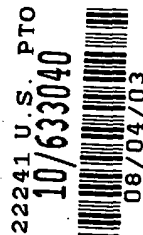


Docket No.: 63979-030

REQUEST FORM FOR CONTINUATION APPLICATION UNDER 35 USC 111(a)

Prior Application: International Application No. PCT/JP03/06041
Art Unit: (Unassigned)
Examiner: (Unassigned)

Assistant Commissioner for Patents
Washington, DC 20231



Sir:

This is a Request for filing a continuation or continuation-in-part application, entitled SEMICONDUCTOR LIGHT EMITTING DEVICE AND FABRICATION METHOD THEREOF, under 35 U.S.C. 111(a) of pending prior International Application No. PCT/JP03/06041, filed on May 15, 2003, entitled SEMICONDUCTOR LIGHT EMITTING DEVICE AND FABRICATION METHOD THEREOF, by the following named inventors:

INVENTOR	RESIDENCE	CITIZENSHIP	POST OFFICE ADDRESS
Akihiko ISHIBASHI	Osaka, JAPAN	JAPANESE	2-22-20-301, Todaiji, Shimamoto-cho, Mishima-gun, Osaka 618-0002 JAPAN
Toshiya YOKOGAWA	Nara, JAPAN	JAPANESE	2-24, Aoyama 5-chome, Nara-shi, Nara 630-8101 JAPAN
Kiyoshi OHNAKA	Osaka, JAPAN	JAPANESE	350, Kodai, Sakai-shi, Osaka 590-0151 JAPAN
Susumu KOIKE	Osaka, JAPAN	JAPANESE	11-39, Nishidai-cho, Kawachinagano-shi, Osaka 586-0016 JAPAN

- ☒ I hereby verify, to the best of my knowledge, that the enclosed copy of this prior application is a true copy of the above-identified prior application, including the oath or declaration as originally filed.
- ☐ Preliminary Amendment is enclosed.
- ☐ An Information Disclosure Statement and PTO1449 Form are submitted herewith.
- ☐ Cancel claims

VERIFICATION OF A TRANSLATION

I, the below named translator, hereby declare that:

My name and post office address are as stated below:

That I am knowledgeable in the English language and in the language in which the below identified international application was filed, and that I believe the English translation of the international application No. PCT/JP03/06041 is a true and complete translation of the above identified international application as filed.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such wilful false statements may jeopardize the validity of the application or any patent issued thereon.

Date

July 24, 2003

Full name of the translator

Tomoko MAEDA

Signature of the translator

Tomoko Maeda

Post Office Address Kitahama TNK Building 7-1, Dosho-machi

1-chome, Chuo-ku, Osaka-shi, Osaka 541-0045

Japan